

REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.H.KIM		2024.06.26.

A

A

B

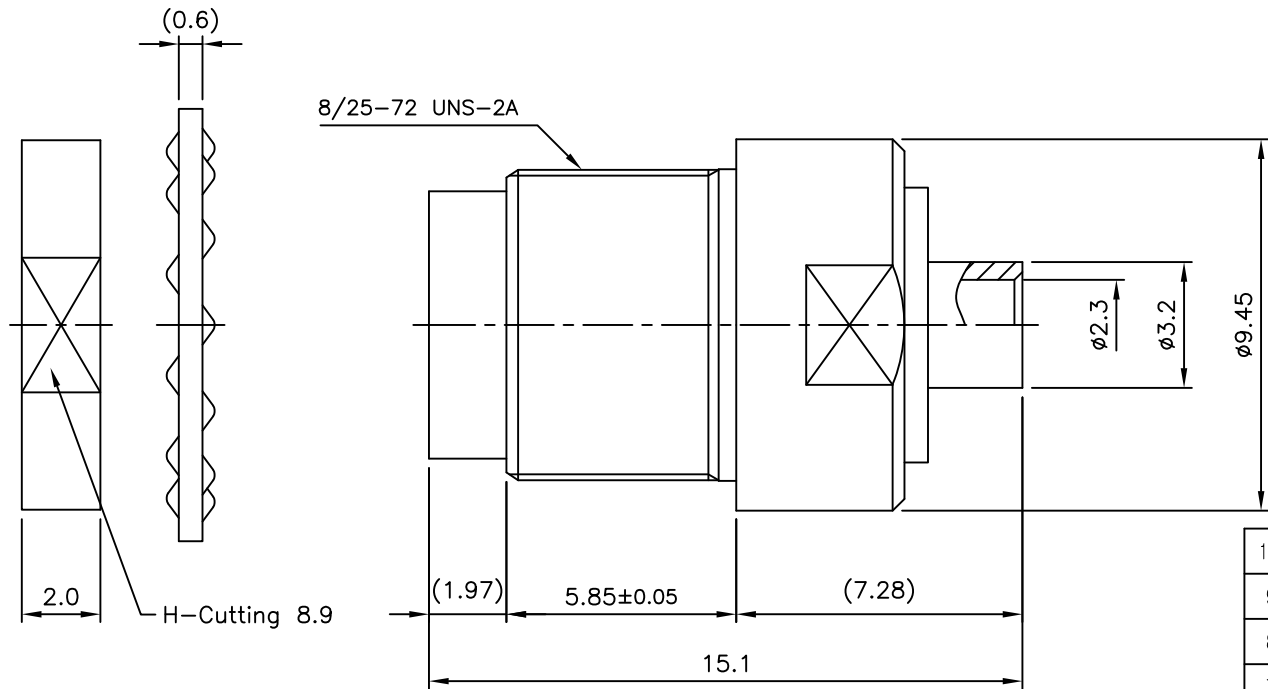
B

C

C

D

D



10	NUT	1	MBsBD C3604BD-F	Suco Plate	DNT00096-5/2
9	WASHER	1	SUS	Passivate	DWA00133-5/1
8	E형 멈춤링	1	SUS	Passivate	DSR01128-5/1
7	PLATE SPRING	1	BeCu C17300	Gold Plate	DPS00002-5/1
6	SPRING	1	SUS	Passivate	DSR01129-5/1
5	INSULATOR	1	TEFLON		DIN02820-N/1
4	COVER	1	MBsBD C3604BD-F	Gold Plate	DIB00026-5/1
3	CONTACT	1	BeCu C17300	Gold Plate (1.27µm)	DCT03747-5/2
2	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD04214-5/4
1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD04213-5/3
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2024. 06. 26.			 COMTECH KJ COMTECH CO.,LTD. RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017		
	Angle ±1°	APPROVED BY					
MATERIAL _____		CHECKED BY		TITLE BMA50 CABLE JB(F/N) 85F			
		DRAWN BY S.H.KIM					
FINISH _____		SCALE 5/1	UNIT mm		A4	DWG NO. CN03374-7/3	
						REVISION I R	SHEET 1 of 1